

SPP15P10PLG-VB Datasheet

P-Channel 100 V (D-S) MOSFET

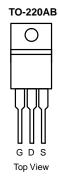
PRODUCT	SUMMARY		
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)
- 100	0.100 at V _{GS} = - 10 V	- 23	11.7
- 100	0.120 at V_{GS} = - 4.5 V	- 20	11.7

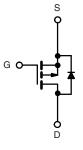
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters





P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _C = 25 °C, unless other	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 100	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	L	- 23		
Continuous Drain Current $(T_j = 150^{\circ} C_j)$	T _C = 70 °C	I _D	- 16		
Pulsed Drain Current		I _{DM}	- 70	A	
Avalanche Current		I _{AS}	- 18		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	16.2	mJ	
······································	T _C = 25 °C		52.1 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	2.5		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W
Junction-to-Case (Drain)	R _{thJC}	3.9	0/11

Notes:

a. Duty cycle ≤ 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



COMPLIANT HALOGEN

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 100			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1		- 2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA	
		V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 150 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 15			А	
	D	V _{GS} = - 10 V, I _D = - 3.6 A		0.100		μΑ	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.120			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S	
Dynamic ^b		· · · · ·					
Input Capacitance	C _{iss}			1055		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65			pF
Reverse Transfer Capacitance	C _{rss}			41			
Tatal Cata Charme	0	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23.2	34.8		
Total Gate Charge ^c	Qg			11.7	17.6	20	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 50 V, V_{GS} = - 4.5 V, I_{D} = - 3.6 A		3.5		nc	
Gate-Drain Charge ^c	Q _{gd}			4.8			
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	V_{DD} = - 50 V, R_L = 17.2 Ω		12	18	20	
Turn-Off Delay Time ^c	t _{d(off)}	$\rm I_D \cong$ - 2.9 A, $\rm V_{GEN}$ = - 10 V, $\rm R_g$ = 1 Ω		33	50	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings a	nd Characteri	istics T _C = 25 °C ^b					
Continuous Current	ا _S				- 8.8	•	
Pulsed Current	I _{SM}				- 15	A	
Forward Voltage ^a	V _{SD}	$I_{F} = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	А	
Reverse Recovery Charge	Q _{rr}	1 1		98	147	nC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

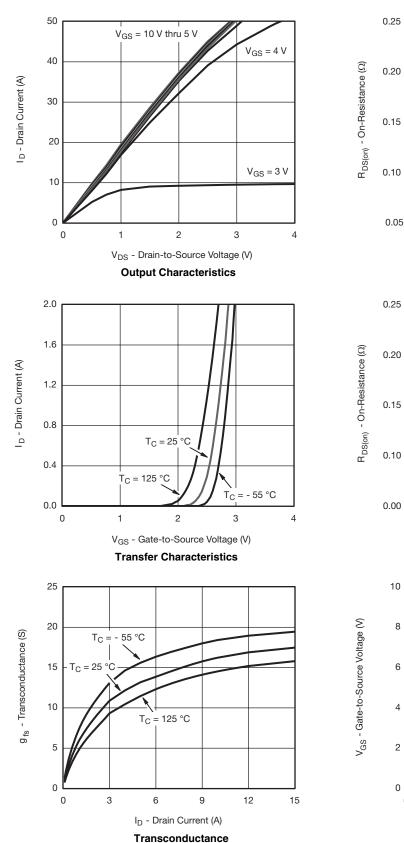
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



 $V_{GS} = 10 V$

12

15



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

I_D - Drain Current (A) On-Resistance vs. Drain Current

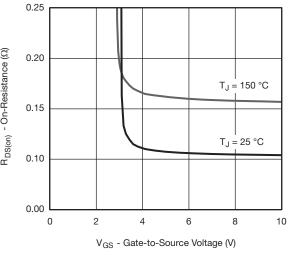
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9

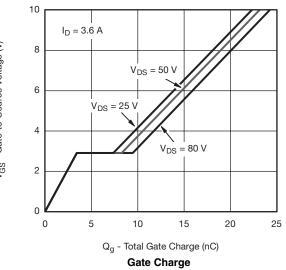
V_{GS} = 4.5 V

3

0

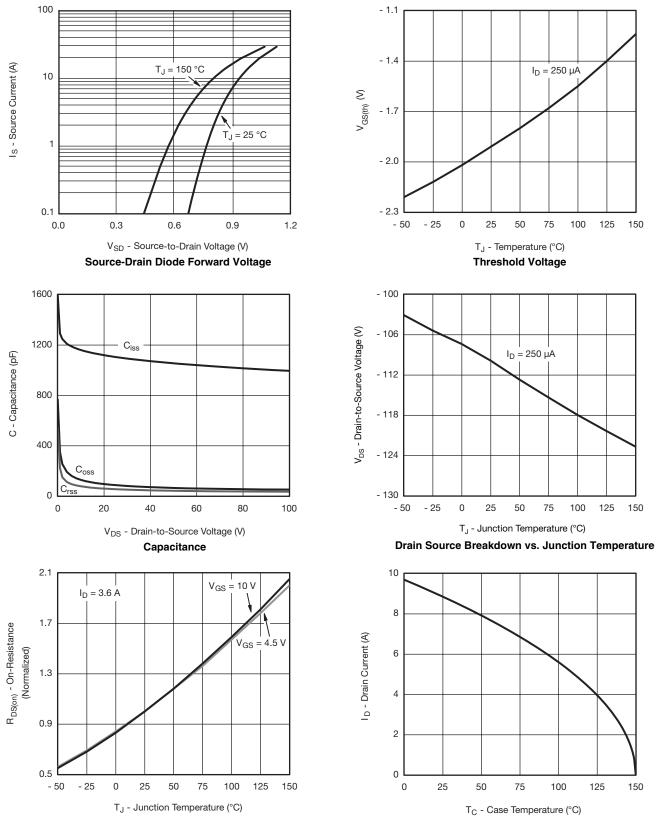


On-Resistance vs. Gate-to-Source Voltage





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

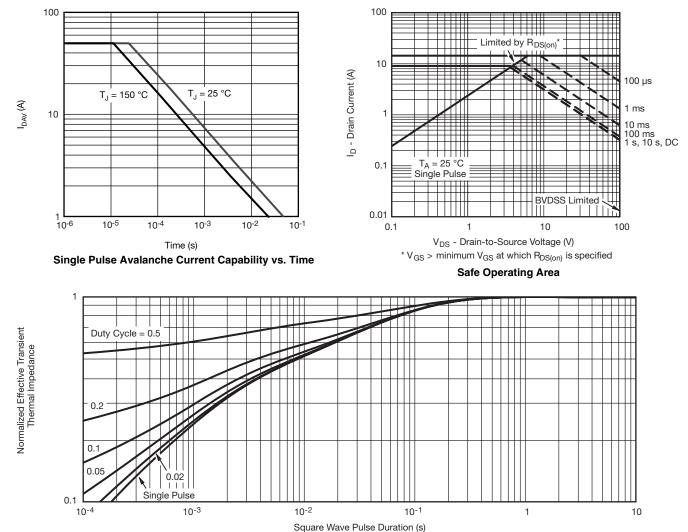


On-Resistance vs. Junction Temperature

Current Derating



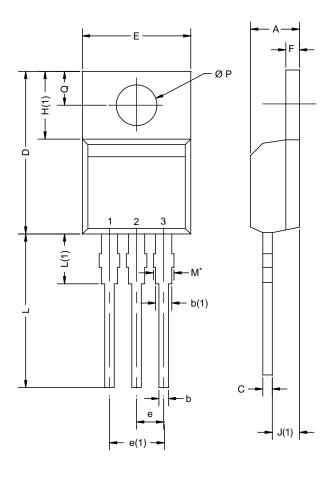
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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